#### BONDING + SEALING + ENCAPSULATION



## Insulation / Flame protection

# Resin 8600/30N (ex ST 36) + Hardener 8901 (ex 1001)

- 2-components polyurethane casting resin
- solvent-free system
- hard curing degree
- no halogenated flame-retardants
- high electrical insulation
- excellent adhesive properties
- ideal for electronic components, e.g. coils, sensors, PCBs or capacitors

#### **Product specification:**

Resin 8600/30N	100 parts	
Hardener 8901	26 parts	
Resin 8600/30N	300 − 700 mPa·s	
Hardener 8901	160 − 240 mPa·s	
Mixing viscosity	300 − 700 mPa·s	
Resin 8600/30N	0.94 - 0.98 g/cm <sup>3</sup>	
Hardener 8901	1.20 – 1.25 g/cm³	
Brown transparent		
25 – 35 minutes		
The curing time depends on the thickness of the layer, the casting		
volume and the temperature.		
16 – 30 hours		
10 – 14 days		
	Resin 8600/30N Hardener 8901 Mixing viscosity Resin 8600/30N Hardener 8901 Brown transparent 25 – 35 minutes The curing time depends on th volume and the temperature. 16 – 30 hours	

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### **Physical properties:**

Shore-Hardness:	A 20 – 30	ISO 868, DIN 53505
Thermal conductivity:	0.2 W/(m·K)	DIN EN ISO 22007
Glass transition temperature:	0.2 °C	ТМА
Coefficient of expansion:	274.3 ppm/K	< Tg, TMA
	244.6 ppm/K	> Tg, TMA
Shrinkage after curing:	<1 %	
Water absorption:	0.5 % (30 days at 23°C)	
Operating temperature:	-60 °C up to +110 °C	

## **Electrical properties:**

Dielectric strength:	24 kV/mm	IEC 60243-1, VDE 0303, TI.2
Volume resistance:	10 <sup>14</sup> Ω·cm (23°C/ 50% r.F.)	IEC 60243-1, VDE0303, TI.30
Surface resistance:	10 <sup>14</sup> Ω (23°C/ 50% r.F.)	IEC 60243-1, VDE0303, TI.30
Dielectric constant ( $\epsilon_r$ ):		
at 50 Hz, 23 °C	5.9	IEC 60250,
at 1 KHz, 23 °C	6.8	VDE 0303, TI.4
at 1 MHz, 23 °C	8.3	
Dissipation factor:		
(tan δ)		150 60250
at 50 Hz, 23 °C	0.08	
at 50 Hz, 50°C	0.12	VDE 0303, TI.4
at 50 Hz, 80°C	0.15	
Comparative Tracking Index:	CTI 600	IEC 60112, VDE 0303, TI.1

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Shelf life:

6 months in sealed original containers when stored in dry conditions (15°C to 25°C).

Packaging:

Resin and hardener are offered in separate packaging units.

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